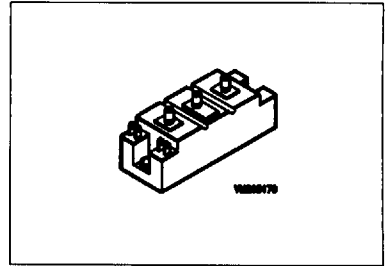


IGBT Module® 750gb16a doc

$V_{CE} = 1600\text{ V}$
 $I_C = 2 \times 100\text{ A at } T_C = 25^\circ\text{C}$
 $I_C = 2 \times 75\text{ A at } T_C = 80^\circ\text{C}$

- Power module
- Half-bridge
- Including fast free-wheel diodes
- Package with insulated metal base plate



Half bridge			
Type	Ordering code	Type	Ordering code
BSM 75 GB 160D	C67076-A2113-A2		

Maximum Ratings

Parameter	Symbol	Values	Unit
Collector emitter voltage	V_{CE}	1600	V
Collector gate voltage, $R_{GE} = 20\text{k}\Omega$	V_{CGR}	1600	
Gate-Emitter voltage	V_{GE}	± 20	
Continuous collector current	I_C	$T_C = 25^\circ\text{C}$	100
		$T_C = 80^\circ\text{C}$	75
Pulsed collector current	$I_C \text{ puls}$	$T_C = 25^\circ\text{C}$	200
		$T_C = 80^\circ\text{C}$	150
Operating and storage temperature range	T_j, T_{stg}	-55...+150	$^\circ\text{C}$
Power dissipation, $T_C = 25^\circ\text{C}$	P_{tot}	625	W
Thermal resistance, chip-case	R_{thJC}	≤ 0.2	K/W
Insulation test voltage ¹⁾ , $t = 1\text{min.}$	V_{is}	4000	V _{ac}
Creepage distance	-	16	mm
Clearance	-	11	
DIN humidity category, DIN 40 040	-	F	--
IEC climatic category, DIN IEC 68-1	-	55/150/56	

¹⁾Insulation test voltage between collector and metal base plate referred to standard climate 23/50 in acc.with DIN 50 014, IEC, para.492.1.

Electrical Characteristics

Parameter and conditions at $T_1 = 25^\circ\text{C}$, unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

Static Characteristics

Collector-emitter breakdown voltage $V_{GE}=0, I_C=1.4\text{mA}$	$V_{(BR)CES}$	1600	-	-	V
Gate threshold voltage $V_{GE}=V_{CE}, I_C=5\text{mA}$	$V_{GE(th)}$	4.8	5.5	6.2	
Collector-emitter saturation voltage $V_{GE}=15\text{V}, I_C=75\text{A}$	$V_{CE(sat)}$				
$T_j = 25^\circ\text{C}$		--	3.7	--	
$T_j = 125^\circ\text{C}$		--	4.6	--	
$T_j = 150^\circ\text{C}$		--	4.8	--	
Zero gate voltage collector current $V_{CE}=1600\text{V}, V_{GE}=0\text{V}$	I_{CES}				μA
$T_j = 25^\circ\text{C}$		--	500	--	
$T_j = 125^\circ\text{C}$		--	4500	--	
Gate-emitter leakage current $V_{GE}=25\text{V}, V_{CE}=0\text{V}$	I_{CES}	--	--	100	nA

AC Characteristics

Forward transconductance $V_{CE}=20\text{V}, I_C=75\text{A}$	g_{fs}	27	--	--	S
Input capacitance $V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	C_{iss}	--	11	--	nF
Output capacitance $V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	C_{oss}	--	0.85	--	
Reverse transfer capacitance $V_{CE}=25\text{V}, V_{GE}=0\text{V}, f=1\text{MHz}$	C_{rss}	--	0.35	--	

Parameter and conditions at $T_j = 25^\circ\text{C}$, unless otherwise specified	Symbol	Values			Unit
		min	typ	max	

Switching Characteristics, Inductive Loadat $T_j=125^\circ\text{C}$

Turn on delay time $V_{CC}=1200\text{V}, V_{GE}=+15\text{V}, I_C=75\text{ A}$ $R_{G(\text{on})}=39\Omega$	$t_{d(\text{on})}$	--	0.35	--	μs
Rise time $V_{CC}=1200\text{V}, V_{GE}=+15\text{V}, I_C=75\text{ A}$ $R_{G(\text{on})}=39\Omega$	t_r	--	0.15	--	μs
Turn off delay time $V_{CC}=1200\text{V}, V_{GE}=-15\text{V}, I_C=75\text{ A}$ $R_{G(\text{off})}=3.3\Omega$	$t_{d(\text{off})}$	--	0.6	--	μs
Fall time $V_{CC}=1200\text{V}, V_{GE}=-15\text{V}, I_C=75\text{ A}$ $R_{G(\text{off})}=3.3\Omega$	t_f	--	0.05	--	μs

Free-Wheel Diode

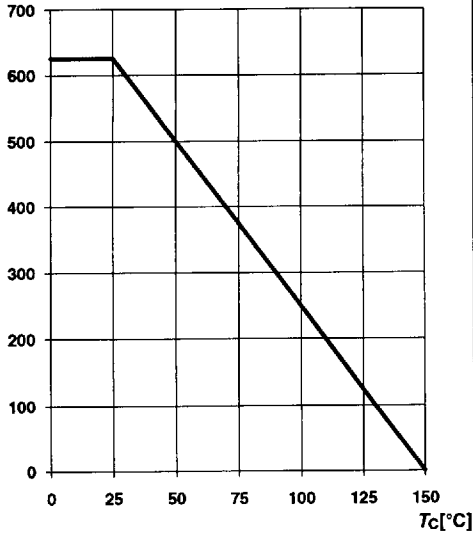
Diode forward voltage $I_F=75\text{ A}, V_{GE}=0\text{V}$ $T_j=25^\circ\text{C}$ $T_j=125^\circ\text{C}$	V_F	--	4.2 3.8	--	V
Reverse recovery time $I_F=75\text{ A}, V_R=-1200\text{V}$ $V_{GE}=0\text{V}, di_F/dt=-500\text{A}/\mu\text{s}$ $T_j=125^\circ\text{C}$	t_{rr}	--	0.5	--	μs
Reverse recovery Charge $I_F=75\text{ A}, V_R=-1200\text{V}$ $V_{GE}=0\text{V}, di_F/dt=-500\text{A}/\mu\text{s}$ $T_j=125^\circ\text{C}$	Q_{rr}	--	25	--	μC
Thermal resistance Chip-Case	R_{thJC}	--	--	0.75	K/W

Power dissipation

$P_{tot} = f(T_C)$

P_{tot} [W]

751pt.xls

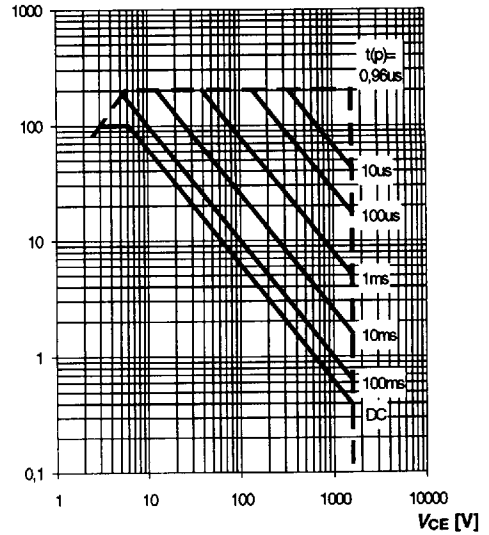


Safe operating area $I_C=f(V_{CE})$

parameter: single pulse, $T_C=25^\circ\text{C}$, $T_J \le 150^\circ\text{C}$

I_C [A]

751tu.xls

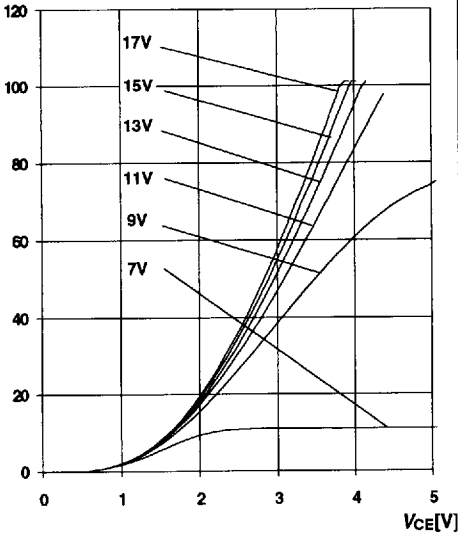


Typ output characteristics $I_C=f(V_{CE})$

parameter: $t_p=80\mu\text{s}$; $T_J=25^\circ\text{C}$

I_C [A]

751us3.xls

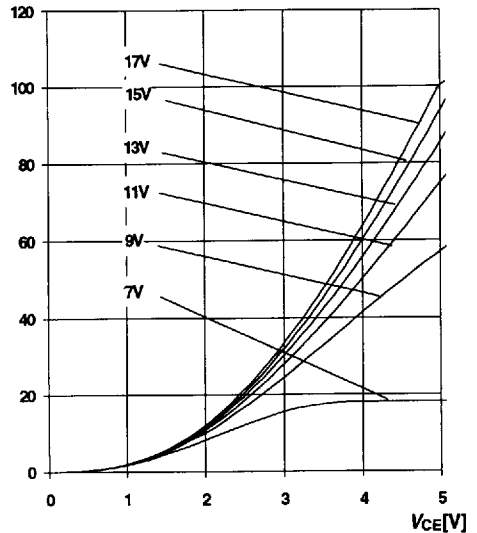


Typ output characteristics $I_C=f(V_{CE})$

parameter: $t_p=80\mu\text{s}$; $T_J < 125^\circ\text{C}$

I_C [A]

751us7.xls

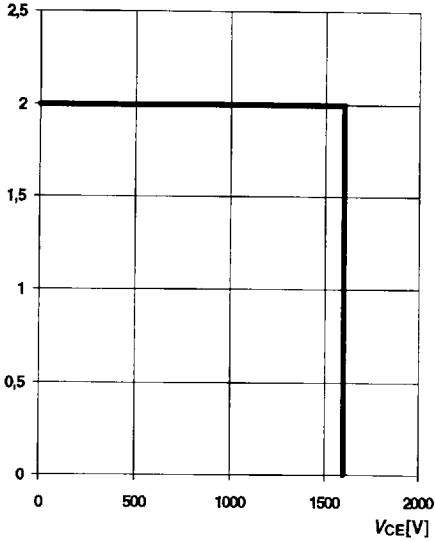


Reverse biased safe operating area

$I_C=f(V_{CE})$, parameter $T_J=150^{\circ}C$
 $V_{GE}=15V, R_{g(off)}=3.3\Omega$

$I_{C(put)}/I_C$

751rso xlc

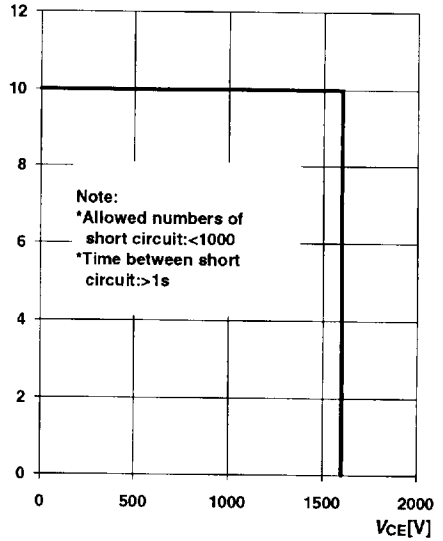


Safe operating area, SHORT CIRCUIT

$I_C=f(V_{CE}), V_{GE}=\pm 15V, T_J\leq 150^{\circ}C$
 $t_{sc}\leq 10\mu s, L<50nH$

$I_{C(sc)}/I_{Cn}$

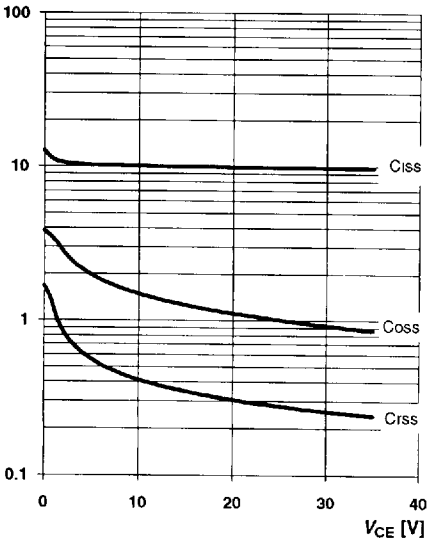
751soas xlc



Typ. capacitances

Parameter: $V_{GE}=0, f=1\text{ MHz}$
 $C\{nF\}$

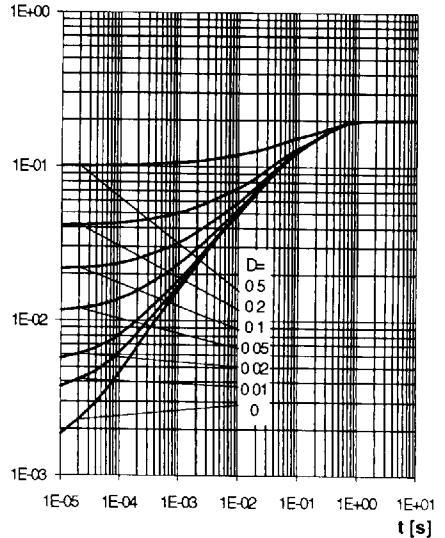
751c xlc



Transient thermal impedance

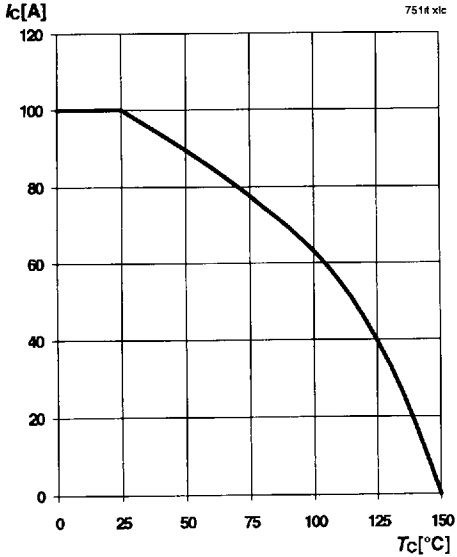
$Z_{thJC} = f(t_p)$, parameter: $D=t_p/T$
 $Z_{thJC} [K/W]$

751zth xlc

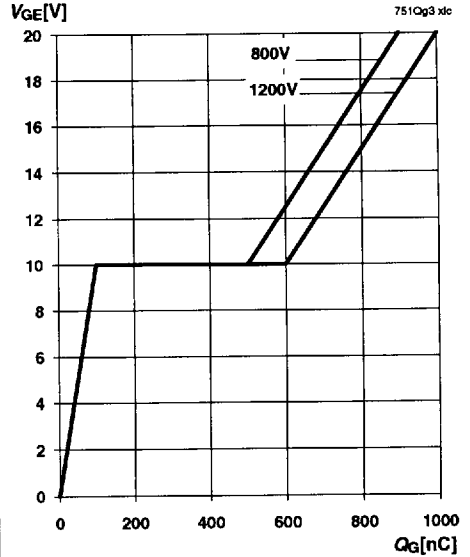


Collector current $I_C=f(T_C)$

parameter: $V_{GE} \geq 15V, T_J = 150^\circ$

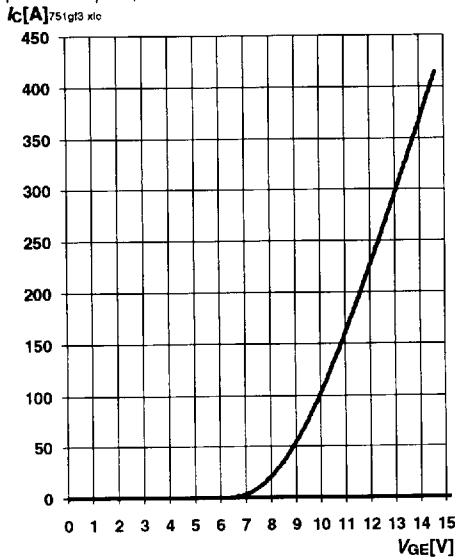


Typ. gate charge, $V_{GE}(Q_G)$



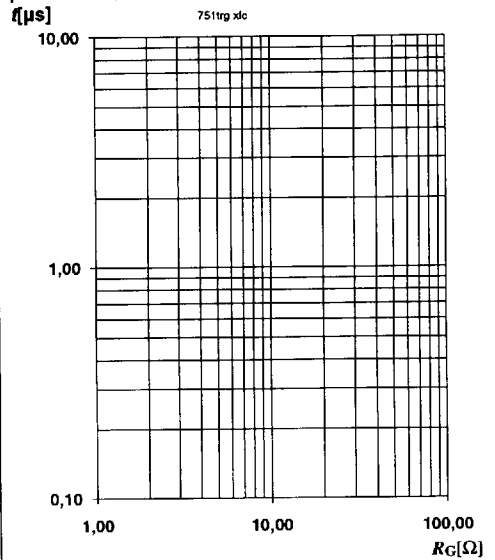
Typ. transfer characteristics $I_C=f(V_{GE})$

parameter: $t_p=80\mu s, V_{CE}=20V$



Typ. switching time $t=f(R_G)$ Inductive load

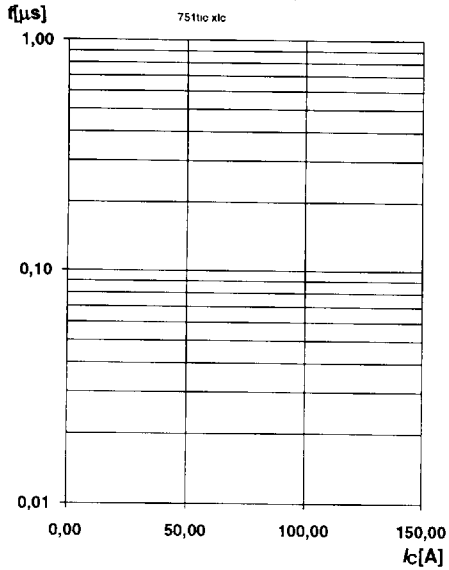
parameter: $T_J=125^\circ C, V_{CE}=1200V, V_{GE}=\pm 15V$



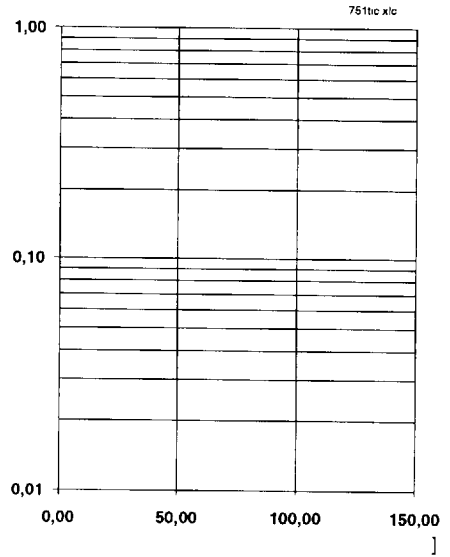
Typ. switching time $t = f(I_c)$

Inductive load, parameter: $T_J = 125^\circ\text{C}$

$V_{CE} = 1200\text{V}$, $V_{GE} = \pm 15\text{V}$, $R_{Gon} = 39\Omega$, $R_{Goff} = 3.3\Omega$

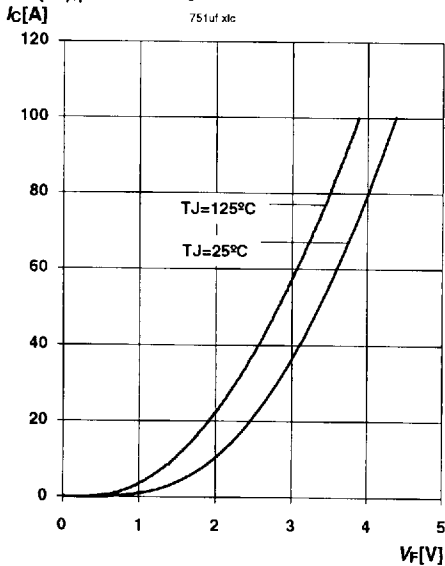


T.

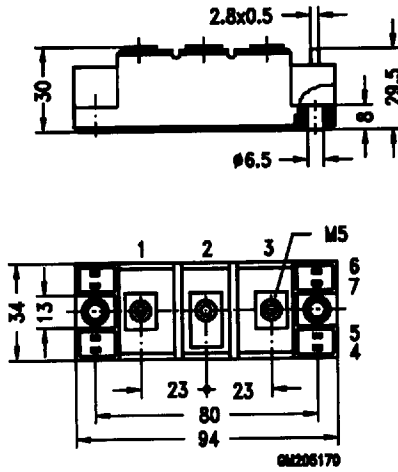


Forward characteristics of fast recovery reverse diode

$I_F = f(V_F)$, parameter: T_J



Package Outlines and Configuration



Circuit

